

NCE P-Channel Enhancement Mode Power MOSFET

Description

The NCE40P40K uses advanced trench technology and design to provide excellent $R_{DS(ON)}$ with low gate charge .This device is well suited for high current load applications.

General Features

- V_{DS} =-40V,I_D =-40A
 R_{DS(ON)} <14mΩ @ V_{GS}=-10V
 R_{DS(ON)} <24mΩ @ V_{GS}=-4.5V
- High density cell design for ultra low Rdson
- Fully characterized avalanche voltage and current
- Good stability and uniformity with high E_{AS}
- Excellent package for good heat dissipation

Application

- Power switching application
- Hard switched and high frequency circuits
- Uninterruptible power supply

Schematic diagram



Marking and pin assignment



TO-252-2L top view

100% ΔVds TESTED! Package Marking and Ordering Information

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Device Marking	Device	Device Package	Reel Size	Tape width	Quantity	
NCE40P40K	NCE40P40K	TO-252-2L	-	-	-	

Absolute Maximum Ratings (Tc=25℃unless otherwise noted)

Parameter	Symbol	Limit	Unit
Drain-Source Voltage	Vds	-40	V
Gate-Source Voltage	V _{GS}	±20	V
Drain Current-Continuous	Ι _D	-40	A
Drain Current-Continuous(T _C =100℃)	I _D (100℃)	-28	A
Pulsed Drain Current	I _{DM}	-160	A
Maximum Power Dissipation (T _C =25°C)	$P_D (T_C=25^{\circ}C)$	80	W
Maximum Power Dissipation $(T_A=25^{\circ}C)$	P _D (T _A =25℃)	2.5	W
Derating factor		0.53	W/℃
Single pulse avalanche energy (Note 5)	E _{AS}	544	mJ
Drain Source voltage slope, V _{DS} ≤-32 V,	dv/dt	50	V/ns
Reverse diode dv/dt, V₀s ≤-32 V, I₅₀ <i₀< td=""><td>dv/dt</td><td>15</td><td>V/ns</td></i₀<>	dv/dt	15	V/ns
Operating Junction and Storage Temperature Range	TJ,TSTG	-55 To 175	°C
Thermal Characteristic			•
Thermal Resistance, Junction-to-Case ^(Note 2)	R _{eJC}	1.88	°C/W
Thermal Resistance, Junction-to-Ambient ^(Note 2)	R _{0JA}	50	°C/W



Electrical Characteristics (T_c=25°C unless otherwise noted)

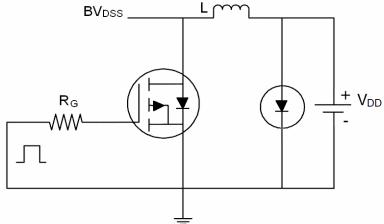
Parameter	Parameter Symbol Condition		Min	Тур	Max	Unit
Off Characteristics	ŀ					
Drain-Source Breakdown Voltage	BV _{DSS}	V _{GS} =0V I _D =-250µA	-40	-	-	V
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} =-40V,V _{GS} =0V	-	-	-1	μA
Gate-Body Leakage Current	I _{GSS}	V _{GS} =±20V,V _{DS} =0V	-	-	±100	nA
On Characteristics (Note 3)	·					
Gate Threshold Voltage	V _{GS(th)}	V _{DS} =V _{GS} ,I _D =-250µA	-1.5	-1.9	-2.5	V
Drain-Source On-State Resistance	D	V _{GS} =-10V, I _D =-12A	-	12	14	mΩ
Drain-Source On-State Resistance	R _{DS(ON)}	V _{GS} =-4.5V, I _D =-12A	-	18.5	24	mΩ
Forward Transconductance	g fs	V _{DS} =-5V,I _D =-12A	-	34	-	S
Dynamic Characteristics (Note4)						
Input Capacitance	C _{lss}		-	2960	-	PF
Output Capacitance	C _{oss}	V _{DS} =-20V,V _{GS} =0V, F=1.0MHz	-	370	-	PF
Reverse Transfer Capacitance	C _{rss}		-	310	-	PF
Switching Characteristics (Note 4)						
Turn-on Delay Time	t _{d(on)}		-	10	-	nS
Turn-on Rise Time	tr	V _{DD} =-20V,I _D =-12A	-	18	-	nS
Turn-Off Delay Time	t _{d(off)}	V _{GS} =-10V,R _G =3Ω	-	38	-	nS
Turn-Off Fall Time	t _f		-	24	-	nS
Total Gate Charge	Qg	V = 20 L = 424	-	42.2	72	nC
Gate-Source Charge	Q _{gs}	V _{DS} =-20,I _D =-12A, V _{GS} =-10V	-	6.9		nC
Gate-Drain Charge	Q _{gd}	v _{GS} =-10v	-	9.7		nC
Drain-Source Diode Characteristics						
Diode Forward Voltage (Note 3)	V _{SD}	V _{GS} =0V,I _S =-12A	-		-1.2	V
Diode Forward Current (Note 2)	I _S		-	-	-40	А
Reverse Recovery Time	t _{rr}	T _J = 25°C, I _F =- 12A	-	40		nS
Reverse Recovery Charge	Qrr	di/dt = -100A/µs ^(Note3)	-	42		nC
Forward Turn-On Time	t _{on}	Intrinsic turn-on time is negligible (turn-on is dominated by LS+LD)				

Notes:

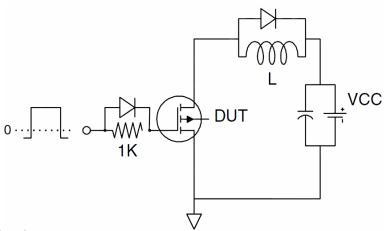
- 1. Repetitive Rating: Pulse width limited by maximum junction temperature.
- **2.** Surface Mounted on FR4 Board with 2oz. Copper, in a still air environment with $T_A=25^{\circ}C_{-}$, t ≤ 10 sec.
- **3.** Pulse Test: Pulse Width \leq 300µs, Duty Cycle \leq 2%.
- 4. Guaranteed by design, not subject to production 5. E_{AS} condition: Tj=25°C, V_{DD} =-20V, V_{G} =-10V,L=1mH,Rg=25 Ω



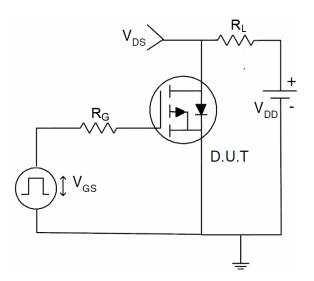
Test Circuit 1) E_{AS} Test Circuit



2) Gate Charge Test Circuit

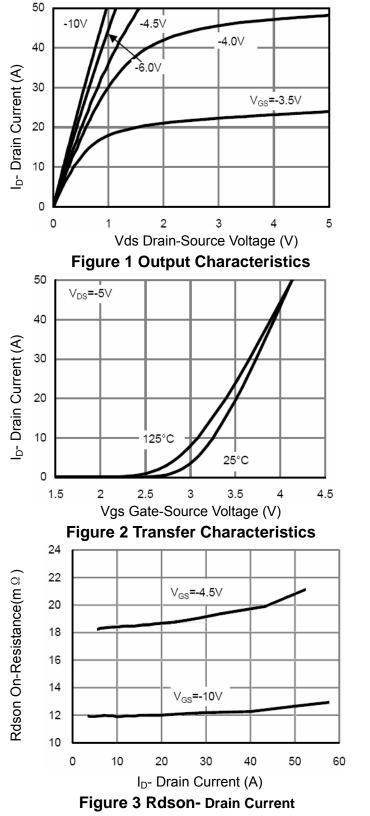


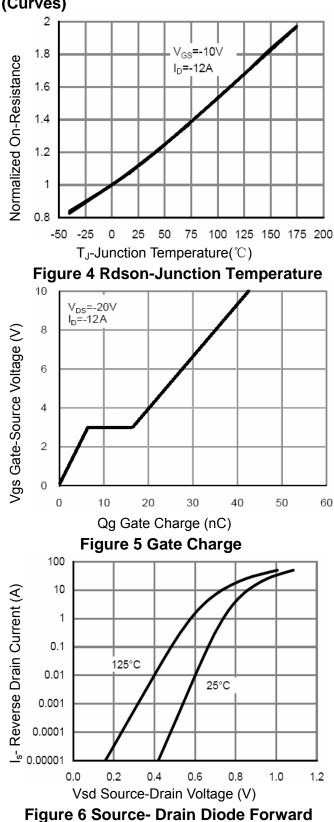
3) Switch Time Test Circuit







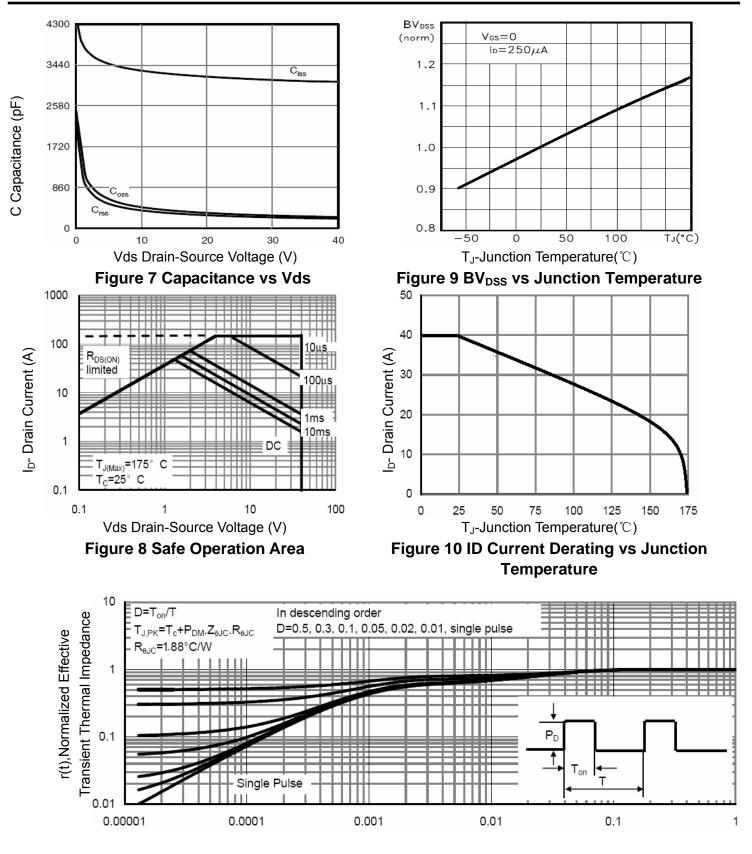






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NCE40P40K



Square Wave Pluse Duration(sec) Figure 11 Normalized Maximum Transient Thermal Impedance



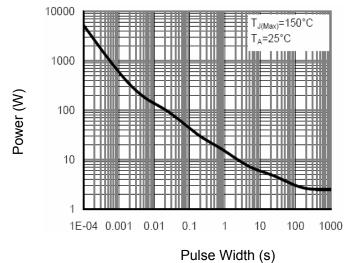
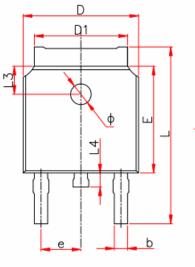
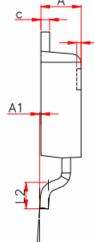


Figure 12 Single Pulse Power Rating Junction-to-Ambient



TO-252 Package Information

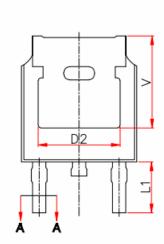




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BASE METAL



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	ECTION A		-	_

Symbol	Millimeters		
Symbol	Min.	Max.	
Α	2.20	2.40	
A1	0.00	0.13	
b	0.66	0.86	
b1	0.73	0.79	
С	0.46	0.58	
c1	0.50	0.52	
D	6.50	6.70	
D1	5.10	5.46	
D2	4.83 REF.		
E	6.00	6.20	
е	2.19	2.39	
L	9.80	10.40	
L1	2.90	REF.	
L2	1.40	1.70	
L3	1.60 REF.		
L4	0.60	1.00	
Φ	1.10	1.30	
θ	0°	8°	



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